

PRODUCT SPECIFICATION

產品規格書

產品名稱 Description

8959 Series QSFP-DD Cage

PRODUCT NAME	DOCUMENT No.:	Rev.	OUPIIN
產品名稱	文件編號	版本	
0050 O. vies OOED DD O. ve	Q8959-PSS-I001	Α	歐品
8959 Series QSFP-DD Cage	Approved	Checked	Prepared
	核準	審核	製作
(RoHS)	Q.A. Section Chief	音(水) Ruru Chen	2024.07.22



1. SCOPE 範圍

This product specification defines the product performance and the test methods to ascertain the performance of the 8959 Series QSFP-DD Cage, which is designed and manufactured by Oupiin Electronic Co., Ltd. This product specification is applicable but not only for those part numbers which be shown in the cover page.

本產品規格書規定了由歐品電子有限公司設計生產的 8959 Series QSFP-DD Cage 型連接器產品的特性及 測試方法。本產品規格書適用於但不局限於封面所顯示的產品料號。

2. REFERENCE DOCUMENTS 參考文件

MIL-STD-1344A Test method for electrical connector 電子連接器測試方法 MIL-STD-202 Test method for electrical components 電子零件測試方法 EIA364 Test method for electrical components 電子零件測試方法

3. FEATURE & DIMENSIONS 特徵及尺寸

3.1. PRODUCT DIMENSION 產品尺寸

These connectors shall have the dimensions as shown in drawing.

本產品的相關尺寸參考圖面。

3.2. PCB/PANEL LAYOUT 印刷電路板佈局

The recommended PCB layout is shown in drawing. 本產品適用的 PCB layout 參考圖面。

3.3. BILL OF MATERIAL 材料清單

Harmful material control follow the requirement of RoHS. The bill of material and product number is described in drawing.

有害物質控制符合RoHS指令要求.本產品使用的材料參考附件。

3.4. MECHANICAL & ELECTRICAL CHARACTERISTIC 機械及電氣特性

The connector shall have the mechanical and electrical performance as described in drawing. 本產品的機械及電氣特性見圖面。

3.5. PACKAGING 包裝

Products shall be packaged according to requirements specified in purchase order for safe delivery, connector container and the packaging method are shown in package specification.

產品可依客戶指定要求包裝,包裝材料與包裝方式參見產品包裝規範。



3.6. STORAGE AND OPERATING TEMPERATURE 儲存與使用溫度

Temperature range: Described in drawing.

Storage Temperature : 0° C ~+ 40° C , Humidity : 80%RH under. Time limit is 12 months the products are

stored.

溫度範圍:參照圖面。

儲存溫度:0℃~+40℃,濕度:80%RH以下,產品限存時間為 12 個月。

4. ENVIRONMENTAL 環境要求

4.1. SOLDERABILITY 可焊性

Connectors meet solder-ability to EIA-364-52.and shall be free of contaminants.

產品可焊性符合 EIA-364-52. 標準規定的相關要求,表面不得有污染物。

4.2. RESISTANCE TO SOLDER HEAT 耐焊接熱

4.2.1. WAVE SOLDER 波峰焊接

Each cycle consists of three consecutive phases. as shown in Table Π]\

每個焊接週期包括三個連續的階段,見附表二。

Note: 說明

Device temperature measurements are referenced from the top-center of the package outer surface.

設備溫度量測時以從頂部中間位置測量為準。

5. PERFORMANCE AND TEST DESCRIPTION 性能及測試

5.1. REQUIREMENT 要求

Product is designed to meet electrical, mechanical, and environmental performance requirements specified in Table I.

本產品設計符合附表一所列的機械,電氣及環境要求。

5.2. TEST CONDITION 測試條件

Unless otherwise specified, all tests shall be performed at ambient environmental conditions. 除非特別註明,所有測試在室溫條件下完成。

5.3. SAMPLE SELECTION 樣品選擇

Test samples shall be selected at random from current production. No test samples shall be reused. Samples are pre-conditioned with 10 cycles of durability. Each group shall be containing 5 test samples. 測試樣品從現生產的產品中隨機抽取,所有測試過的樣品不得重複使用. 樣品已預先插拔10次,每組測試有5個樣品。



Table I: Test Requirements and Methods

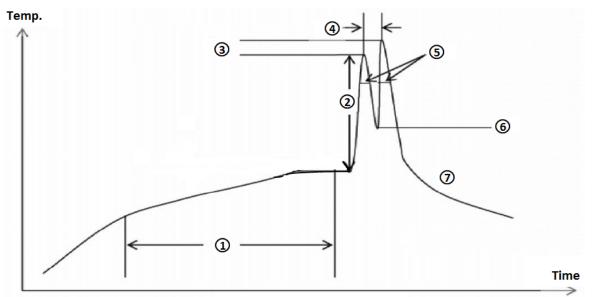
附表一: 測試要求與方法

Items	Requirements	Test Methods
項目	要求	測試方法
1. Confirmation of	Product shall be conforming to the	Visually, dimensions and functionally inspected
Product	requirements of applicable product	per applicable product drawing.
產品確認	drawing.	依相關產品圖面,檢查產品的外觀、尺寸及功能。
	產品必須符合相關產品圖面的要求。	
2. Solder-ability	There shall have a solder coverage of	Soldering time: 3 to 5 Seconds
可焊性	95% minimum.	Soldering Temperature ∶ 245±5℃.
	產品在測試完成後,焊接部位粘錫面積	Per EIA-364-52
	大於 95%。	焊接時間:3~5 秒。
		焊接温度: 245±5 ℃。
		適用:EIA-364-52



Table Π : Weld the curve graph in crest

附表二:波峰焊曲線圖



- ① Preheat 80sec (1~2°C/s)
- ②ΔT<150°C
- 3235~245℃
- 41~3sec

- ⑤Dip Time 3~6sec ⑥>200°C
- ⑦Cooling-5℃/s